

# SANYO Semiconductors DATA SHEET

# WPB4002 — General-Purpose Switching Device Applications

#### **Features**

- Reverse recovery time t<sub>rr</sub>=115ns (typ)
- Input capacitance Ciss=2200pF (typ)
- ON-resistance RDS(on)= $0.28\Omega$  (typ)
- · 10V drive

# **Specifications**

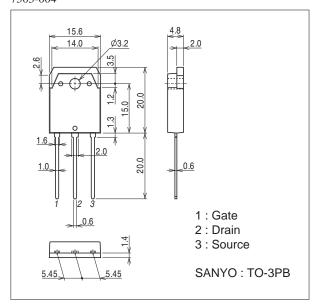
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		600	V
Gate-to-Source Voltage	VGSS		±30	V
Drain Current (DC)	ID		23	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	80	А
Source-to-Drain Diode Forward Current (DC)	ISD		23	А
Source-to-Drain Diode Forward Current (Pulse)	ISDP	PW≤10μs, duty cycle≤1%	80	А
Allowable Power Dissipation	PD		2.5	W
		Tc=25°C	220	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		172	mJ
Avalanche Current *2	I <sub>AV</sub>		17	Α

Note: \*1 VDD=99V, L=1mH, IAV=17A (Fig.1)

#### **Package Dimensions**

unit : mm (typ) 7503-004



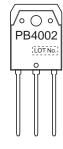
### **Product & Package Information**

• Package : TO-3PB

• JEITA, JEDEC : SC-65, TO-247, SOT199

• Minimum Packing Quantity : 100 pcs. / tray

# Marking



<sup>\*2</sup> L≤1mH, single pulse

# **Electrical Characteristics** at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	600			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =480V, V <sub>GS</sub> =0V			100	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	3		5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =11.5A	7.5	15		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =11.5A, V <sub>G</sub> S=10V		0.28	0.36	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =30V, f=1MHz		2200		pF
Output Capacitance	Coss	V <sub>DS</sub> =30V, f=1MHz		400		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =30V, f=1MHz		83		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See Fig.2		42		ns
Rise Time	t <sub>r</sub>	See Fig.2		130		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See Fig.2		234		ns
Fall Time	tf	See Fig.2		84		ns
Total Gate Charge	Qg	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =23A		84		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =23A		15.2		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =23A		45.4		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =23A, V <sub>G</sub> S=0V		1.1	1.5	V
Reverse Recovery Time	t <sub>rr</sub>	See Fig.3		115		ns
Reverse Recovery Charge	Q <sub>rr</sub>	ISD=23A, VGS=0V, di/dt=100A/μs		340		nC

Fig.1 Avalanche Resistance Test Circuit

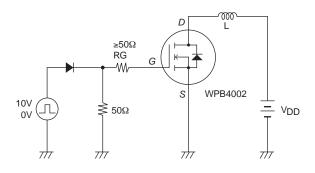


Fig.2 Switching Time Test Circuit

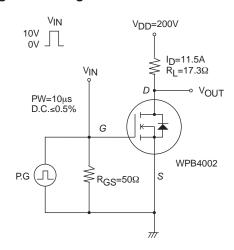
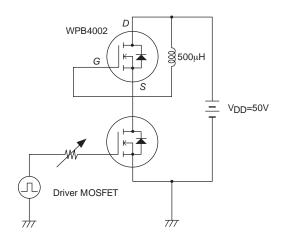
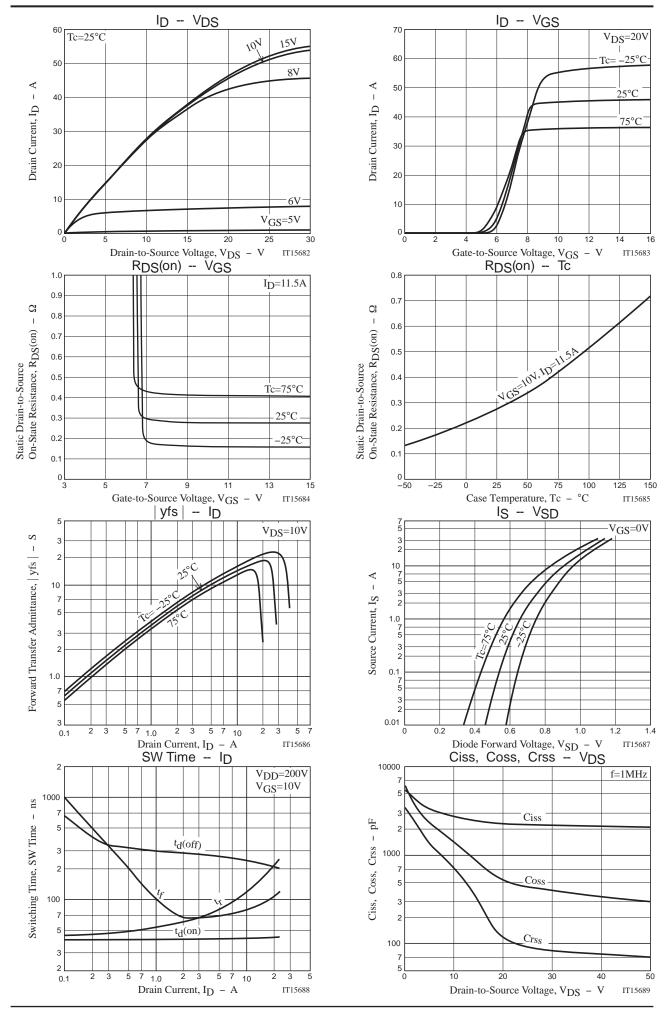
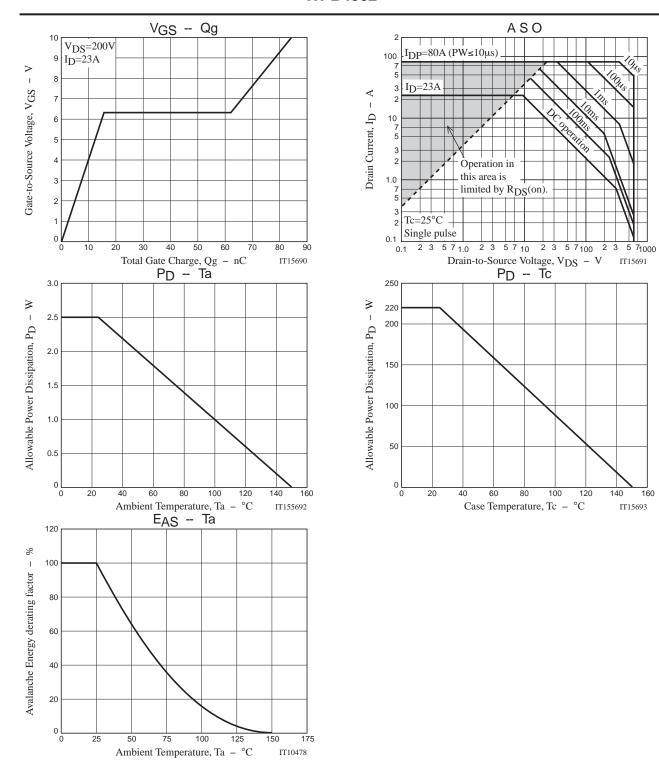


Fig.3 t<sub>rr</sub> Reverse Recovery Resistance Test Circuit







140

160

IT15693

Note on usage: Since the WPB4002 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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